

# AN7082K

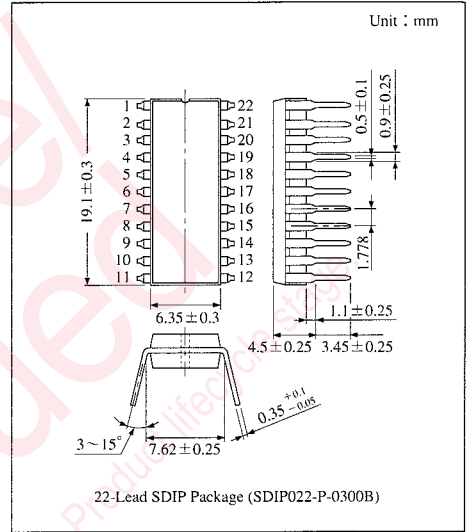
Pre-/Power Amplifier, Governor Single Chip IC for 3V Headphone Stereo

### Overview

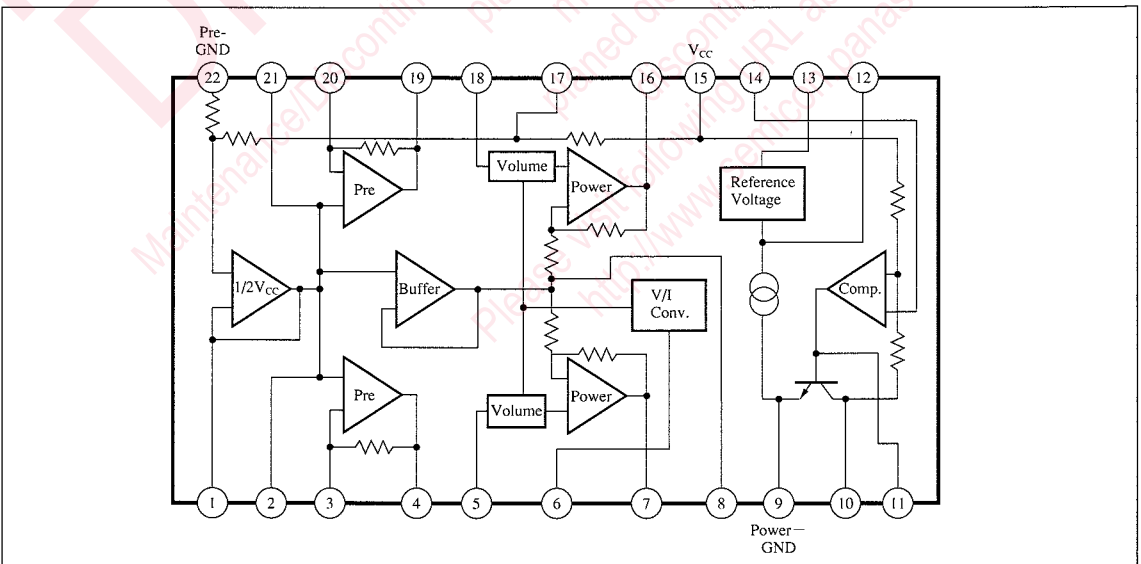
The AN7082K is a bipolar IC most suitable for stereo headphone cassette player integrated pre-amp., power amp., motor governor into a single chip and built-in electronic VR.

### Features

- Wide operating supply voltage range :  $V_{CC (opr.)} = 1.8V \sim 6V$
- Fewer peripheral parts
- Both channel VR control by single string VR is possible due to electronic VR built-in.
- Available for graphic equalizer



### Block Diagram



### ■ Absolute Maximum Ratings (Ta=25°C)

Parameter	Symbol	Rating	Unit
Supply Voltage	V <sub>CC</sub>	7	V
Supply Current	I <sub>CC</sub>	1000	mA
Power Dissipation	P <sub>D</sub>	1000	mW
Operating Ambient Temperature	T <sub>opr</sub>	-25 ~ +75	°C
Storage Temperature	T <sub>stg</sub>	-55 ~ +150	°C

### ■ Recommended Operating Range (Ta=25°C)

Parameter	Symbol	Range
Operating Supply Voltage Range	V <sub>CC</sub>	1.8 ~ 6.0V

### ■ Electrical Characteristics (V<sub>CC</sub>=3V, f=1kHz, R<sub>L</sub>=32Ω, Ta=25°C)

Parameter	Symbol	Condition	min.	typ.	max.	Unit
Supply Current	I <sub>CQ</sub>	V <sub>i</sub> =0V, I <sub>m</sub> =0mA	10	20	35	mA

#### <Pre Amplifier>

Close-Loop Gain	G <sub>VC</sub>	V <sub>O</sub> =0.3V	34	37.5	40	dB
Maximum Output Voltage	V <sub>om</sub>	THD=1%	0.6	0.8	—	V
Total Harmonic Distortion	THD	V <sub>O</sub> =300mV <sub>rms</sub>	—	0.05	0.5	%
Input Noise Voltage	V <sub>ni</sub>	V <sub>i</sub> =0V, R <sub>g</sub> =2.2kΩ BPF (300Hz~20kHz)	—	1.8	5.0	μV
Channel Balance	CB	V <sub>in</sub> =5mV <sub>rms</sub>	-2	0	+2	dB

#### <Attenuator>

Maximum Attenuation	V <sub>aM</sub>	V <sub>i</sub> =0.4V, PinⓄ=0	60	65	—	dB
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#### <Power Amplifier>

Voltage Gain	G <sub>V</sub>	P <sub>out</sub> =5mW	25.5	28	30.5	dB
Maximum Power	P <sub>om1</sub>	THD=10% R <sub>L</sub> =32Ω	15	20	—	mW
Total Harmonic Distortion	THD	P <sub>out</sub> =5mW	—	0.2	1.0	%
Channel Balance	CB	V <sub>O</sub> =0.4V <sub>rms</sub>	-2	0	2	dB
Output Noise Voltage	V <sub>no</sub>	BPF (300Hz~20kHz)	—	0.3	0.4	mV
Ripple Rejection	RR	f=100Hz, 50mV	34	40	—	dB
Cross-Talk	CT	V <sub>O</sub> =0.6V <sub>rms</sub>	25	35	—	dB

#### <Motor Governor>

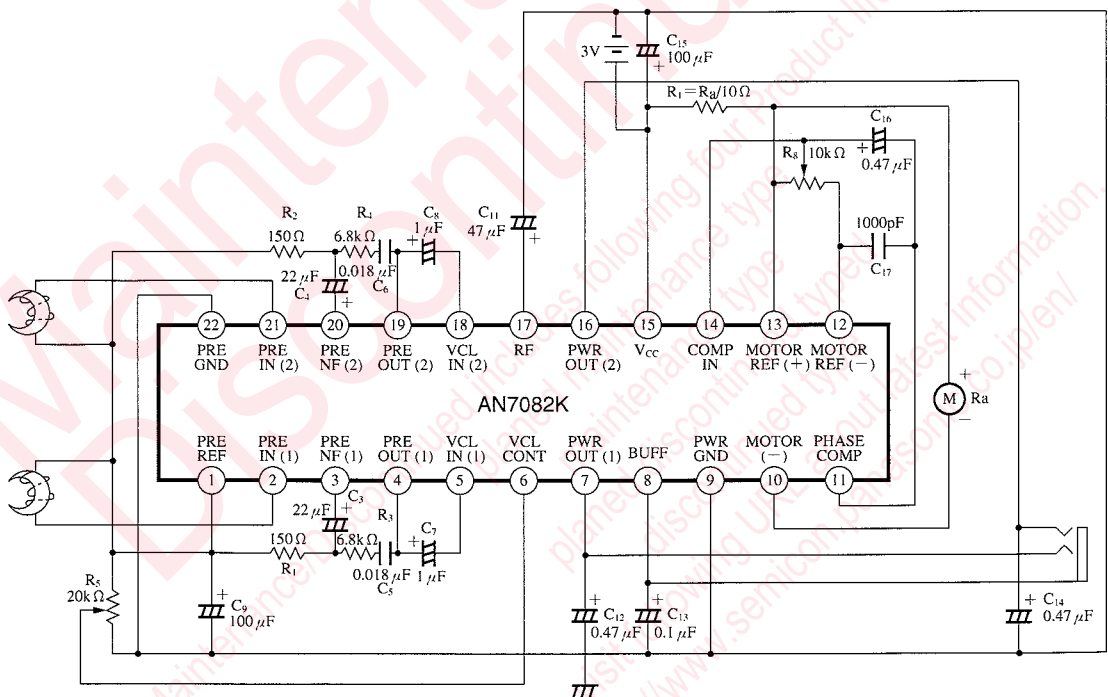
Load Regulation 1	$\frac{\Delta V_a}{V_a} / \Delta I_a$	I <sub>O</sub> =30mA~200mA	—	0.01	0.1	%/mA
Line Regulation 1	$\frac{\Delta V_a}{V_a} / \Delta V_{CC}$	I <sub>m</sub> =50mA V <sub>CC</sub> =1.8~6.0V	—	0.1	1.0	%/V
Reference Voltage	V <sub>REF</sub>	I <sub>m</sub> =100mA R <sub>13-12</sub> >10kΩ	—	1.28	—	V
Saturation Voltage	V <sub>sat</sub>	I <sub>m</sub> =100mA, 1.8V R <sub>a</sub> =4.7Ω	—	0.2	—	V
Line Regulation 2	$\frac{\Delta V_{REF}}{V_{REF}} / \Delta V_{CC}$	I <sub>m</sub> =50mA V <sub>CC</sub> =1.8~6.0V	—	0.2	—	%/V
Temp. Characteristics	$\frac{\Delta V_a}{V_a} / \Delta T_a$	T <sub>a</sub> =-25°C~75°C	—	0.01	—	%/°C

ICs for  
Cassette  
Deck

Pin Descriptions

Pin No.	Pin Name	Pin No.	Pin Name
1	Pre-V <sub>REF</sub>	12	Motor Ref. Voltage (-)
2	Channel 1 Pre Amp. Input	13	Motor Ref. Voltage (+)
3	Channel 1 Pre Negative Feedback	14	Comparator Input
4	Channel 1 Pre Amp. Output	15	V <sub>CC</sub> Supply
5	Channel 1 Volume Input	16	Channel 2 Power Amp. Output
6	Volume Control	17	Ripple Filter
7	Channel 1 Power Amp. Output	18	Channel 2 Volume Input
8	Buffer Output	19	Channel 2 Pre Amp. Output
9	Power/Motor Ground	20	Channel 2 Pre Negative Feedback
10	Motor Terminal (-)	21	Channel 2 Pre Amp. Input
11	Phase Compensation	22	Pre-Ground

Application Circuit



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